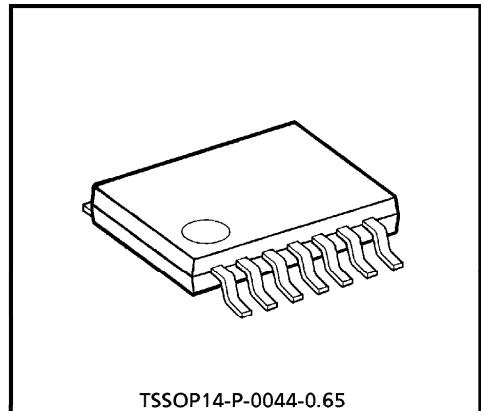


TC74VCX86FT**LOW-VOLTAGE QUAD EXCLUSIVE OR GATE
WITH 3.6V TOLERANT INPUTS AND OUTPUTS**

The TC74VCX86FT is a high performance CMOS EXCLUSIVE OR GATE. Designed for use in 1.8, 2.5 or 3.3 Volt systems, it achieves high speed operation while maintaining the CMOS low power dissipation. It is also designed with over voltage tolerant inputs and outputs up to 3.6V. All inputs are equipped with protection circuits against static discharge.

FEATURES

- Low Voltage Operation : $V_{CC} = 1.8 \sim 3.6V$
- High Speed Operation : $t_{pd} = TBD$ (max.) at $V_{CC} = 3.0 \sim 3.6V$
 $t_{pd} = TBD$ (max.) at $V_{CC} = 2.3 \sim 2.7V$
 $t_{pd} = TBD$ (max.) at $V_{CC} = 1.8V$
- 3.6V Tolerant inputs and outputs.
- Output Current : $I_{OH}/I_{OL} = \pm 24mA$ (min.) at $V_{CC} = 3.0V$
 $I_{OH}/I_{OL} = \pm 18mA$ (min.) at $V_{CC} = 2.3V$
 $I_{OH}/I_{OL} = \pm 6mA$ (min.) at $V_{CC} = 1.8V$
- Latch-up Performance : $\pm 300mA$
- ESD Performance : Human Body Model $> \pm 2000V$
Machine Model $> \pm 200V$
- Package : TSSOP
(Thin Shrink Small Outline Package)
- Power Down Protection is provided on all inputs and outputs.



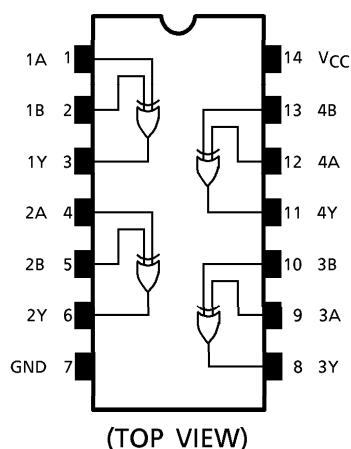
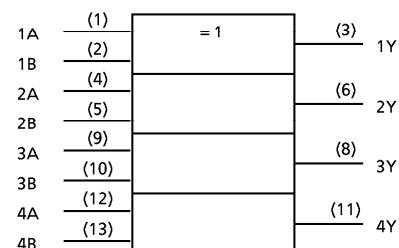
TSSOP14-P-0044-0.65

Weight : 0.06g (Typ.)

PRELIMINARY

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PIN ASSIGNMENT**IEC LOGIC SYMBOL****TRUTH TABLE**

INPUTS		OUTPUTS
A	B	Y
L	L	L
L	H	H
H	L	H
H	H	L

PRELIMINARY

MAXIMUM RATINGS

PARAMETER	SYMBOL	RATING	UNIT
Power Supply Voltage	V_{CC}	-0.5~4.6	V
DC Input Voltage	V_{IN}	-0.5~4.6	V
DC Output Voltage	V_{OUT}	-0.5~4.6 (Note 1)	V
		-0.5~ V_{CC} + 0.5 (Note 2)	
Input Diode Current	I_{IK}	-50	mA
Output Diode Current	I_{OK}	± 50 (Note 3)	mA
DC Output Current	I_{OUT}	± 50	mA
Power Dissipation	P_D	180	mW
DC V_{CC} / Ground Current	I_{CC} / I_{GND}	± 100	mA
Storage Temperature	T_{stg}	-65~150	°C

(Note 1) $V_{CC} = 0V$ (Note 2) High or Low State. I_{OUT} absolute maximum rating must be observed.(Note 3) $V_{OUT} < GND, V_{OUT} > V_{CC}$

RECOMMENDED OPERATING RANGE

PARAMETER	SYMBOL	RATING	UNIT
Supply Voltage	V_{CC}	1.8~3.6	V
		1.2~3.6 (Note 4)	
Input Voltage	V_{IN}	-0.3~3.6	V
Output Voltage	V_{OUT}	0~3.6 (Note 5)	V
		0~ V_{CC} (Note 6)	
Output Current	I_{OH} / I_{OL}	± 24 (Note 7)	mA
		± 18 (Note 8)	
		± 6 (Note 9)	
Operating Temperature	T_{opr}	-40~85	°C
Input Rise And Fall Time	dt/dv	0~10 (Note 10)	ns/V

(Note 4) Data Retention Only

(Note 5) $V_{CC}=0V$

(Note 6) High or Low State

(Note 7) $V_{CC}=3.0\sim 3.6V$ (Note 8) $V_{CC}=2.3\sim 2.7V$ (Note 9) $V_{CC}=1.8V$ (Note 10) $V_{IN}=0.8\sim 2.0V$, $V_{CC}=3.0V$

PRELIMINARY

ELECTRICAL CHARACTERISTICS

DC characteristics ($T_a = -40\sim 85^\circ C$, $2.7V < V_{CC} \leq 3.6V$)

PARAMETER	SYMBOL	TEST CONDITION		V_{CC} (V)	MIN.	MAX.	UNIT	
Input Voltage	"H" Level	V_{IH}		2.7~3.6	2.0	—	V	
	"L" Level	V_{IL}		2.7~3.6	—	0.8		
Output Voltage	"H" Level	V_{OH}	$V_{IN}=V_{IH}$ or V_{IL}	$I_{OH} = -100\mu A$	2.7~3.6	$V_{CC} - 0.2$	V	
				$I_{OH} = -12mA$	2.7	2.2		
				$I_{OH} = -18mA$	3.0	2.4		
				$I_{OH} = -24mA$	3.0	2.2		
	"L" Level	V_{OL}	$V_{IN}=V_{IH}$ or V_{IL}	$I_{OL} = 100\mu A$	2.7~3.6	—	V	
				$I_{OL} = 12mA$	2.7	—		
				$I_{OL} = 18mA$	3.0	—		
				$I_{OL} = 24mA$	3.0	—		
Input Leakage Current	I_{IN}	$V_{IN}=0\sim 3.6V$		2.7~3.6	—	± 5.0	μA	
Power Off Leakage Current	I_{OFF}	$V_{IN}, V_{OUT}=0\sim 3.6V$		0	—	10.0	μA	
Quiescent Supply Current	I_{CC}	$V_{IN}=V_{CC}$ or GND		2.7~3.6	—	20.0	μA	
		$V_{CC} \leq (V_{IN}, V_{OUT}) \leq 3.6V$		2.7~3.6	—	± 20.0		
Increase In I_{CC} Per Input	ΔI_{CC}	$V_{IH}=V_{CC}-0.6V$		2.7~3.6	—	750	μA	

ELECTRICAL CHARACTERISTICSDC characteristics ($T_a = -40\sim85^\circ C$, $2.3V \leq V_{CC} \leq 2.7V$)

PARAMETER		SYMBOL	TEST CONDITION		V_{CC} (V)	MIN.	MAX.	UNIT	
Input Voltage	"H" Level	V_{IH}			2.3~2.7	1.6	—	V	
	"L" Level	V_{IL}			2.3~2.7	—	0.7		
Output Voltage	"H" Level	V_{OH}	$V_{IN} = V_{IH}$ or V_{IL}	$I_{OH} = -100\mu A$	2.3~2.7	$V_{CC} - 0.2$	—	V	
				$I_{OH} = -6mA$	2.3	2.0	—		
				$I_{OH} = -12mA$	2.3	1.8	—		
				$I_{OH} = -18mA$	2.3	1.7	—		
	"L" Level	V_{OL}	$V_{IN} = V_{IH}$ or V_{IL}	$I_{OL} = 100\mu A$	2.3~2.7	—	0.2	V	
				$I_{OL} = 12mA$	2.3	—	0.4		
				$I_{OL} = 18mA$	2.3	—	0.6		
Input Leakage Current		I_{IN}	$V_{IN} = 0\sim 3.6V$		2.3~2.7	—	± 5.0	μA	
Power Off Leakage Current		I_{OFF}	$V_{IN}, V_{OUT} = 0\sim 3.6V$		0	—	10.0	μA	
Quiescent Supply Current		I_{CC}	$V_{IN} = V_{CC}$ or GND		2.3~2.7	—	20.0	μA	
			$V_{CC} \leq (V_{IN}, V_{OUT}) \leq 3.6V_{CC}$		2.3~2.7	—	± 20.0		

PRELIMINARY

ELECTRICAL CHARACTERISTICSDC characteristics ($T_a = -40\sim85^\circ C$, $1.8V \leq V_{CC} < 2.3V$)

PARAMETER		SYMBOL	TEST CONDITION		V_{CC} (V)	MIN.	MAX.	UNIT	
Input Voltage	"H" Level	V_{IH}			1.8~2.3	$0.7 \times V_{CC}$	—	V	
	"L" Level	V_{IL}			2.8~2.3	—	$0.2 \times V_{CC}$		
Output Voltage	"H" Level	V_{OH}	$V_{IN} = V_{IH}$ or V_{IL}	$I_{OH} = -100\mu A$	1.8	$V_{CC} - 0.2$	—	V	
				$I_{OH} = -6mA$	1.8	1.4	—		
	"L" Level	V_{OL}	$V_{IN} = V_{IL}$	$I_{OL} = 100\mu A$	1.8	—	0.2		
				$I_{OL} = 6mA$	1.8	—	0.3		
Input Leakage Current	I_{IN}	$V_{IN} = 0\sim 3.6V$				1.8	—	± 5.0 μA	
Power Off Leakage Current	I_{OFF}	$V_{IN}, V_{OUT} = 0\sim 3.6V$				0	—	10.0 μA	
Quiescent Supply Current	I_{CC}	$V_{IN} = V_{CC}$ or GND				1.8	—	20.0 μA	
		$V_{CC} \leq (V_{IN}, V_{OUT}) \leq 3.6V$				1.8	—	± 20.0 μA	

AC characteristics ($T_a = -40\sim85^\circ C$, Input $t_r = t_f = 2.0ns$, $C_L = 30pF$, $R_L = 500\Omega$)

PARAMETER		SYMBOL	TEST CONDITION		V_{CC} (V)	MIN.	MAX.	UNIT
Propagation Delay Time	t_{pLH} t_{pHL}	(Fig.1, 2)			1.8	1.5	TBD	ns
					2.5 ± 0.2	1.0	TBD	
					3.3 ± 0.3	0.8	TBD	
Output To Output Skew	t_{osLH} t_{osHL}	(Note 11)			1.8	—	TBD	ns
					2.5 ± 0.2	—	TBD	
					3.3 ± 0.3	—	TBD	

For $C_L = 50pF$, add approximately 300ps to the AC maximum specification.

(Note 11) Parameter guaranteed by design.

$$(t_{osLH} = |t_{pLHm} - t_{pLHn}|, t_{osHL} = |t_{pHLm} - t_{pHLn}|)$$

Dynamic switching characteristics ($T_a = 25^\circ\text{C}$, Input $t_r = t_f = 2.0\text{ns}$, $C_L = 30\text{pF}$)

PARAMETER	SYMBOL	TEST CONDITION		V _{CC} (V)	TYP.	UNIT
		V _{IH}	V _{IL}			
Quiet Output Maximum Dynamic V _{OL}	V _{OLP}	V _{IH} = 1.8V, V _{IL} = 0V	(Note 12)	1.8	TBD	V
		V _{IH} = 2.5V, V _{IL} = 0V	(Note 12)	2.5	TBD	
		V _{IH} = 3.3V, V _{IL} = 0V	(Note 12)	3.3	TBD	
Quiet Output Minimum Dynamic V _{OL}	V _{OLV}	V _{IH} = 1.8V, V _{IL} = 0V	(Note 12)	1.8	TBD	V
		V _{IH} = 2.5V, V _{IL} = 0V	(Note 12)	2.5	TBD	
		V _{IH} = 3.3V, V _{IL} = 0V	(Note 12)	3.3	TBD	
Quiet Output Minimum Dynamic V _{OH}	V _{OHV}	V _{IH} = 1.8V, V _{IL} = 0V	(Note 12)	1.8	TBD	V
		V _{IH} = 2.5V, V _{IL} = 0V	(Note 12)	2.5	TBD	
		V _{IH} = 3.3V, V _{IL} = 0V	(Note 12)	3.3	TBD	

(Note 12) Parameter guaranteed by design.

Capacitive characteristics ($T_a = 25^\circ\text{C}$)

PARAMETER	SYMBOL	TEST CONDITION		V _{CC} (V)	TYP.	UNIT
		—	—			
Input Capacitance	C _{IN}	—	—	1.8, 2.5, 3.3	TBD	pF
Output Capacitance	C _{OUT}	—	—	0	TBD	pF
Power Dissipation Capacitance	C _{PD}	f _{IN} = 10MHz	(Note 13)	1.8, 2.5, 3.3	TBD	pF

(Note 13) C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

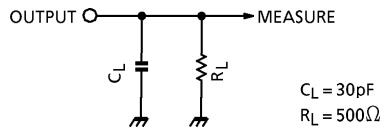
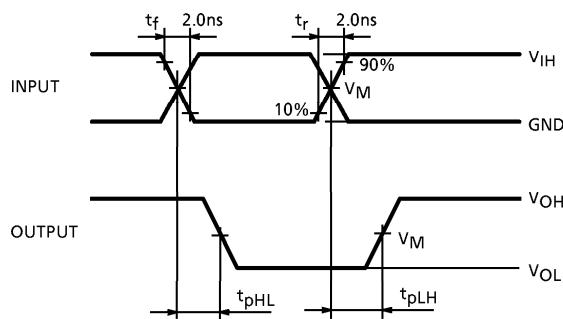
Average operating current can be obtained by the equation :

$$I_{CC(\text{opr.})} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/4 \text{ (per gate)}$$

PRELIMINARY

TEST CIRCUIT

Fig.1

**AC WAVEFORM**Fig.2 t_{pLH} , t_{pHL} 

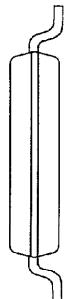
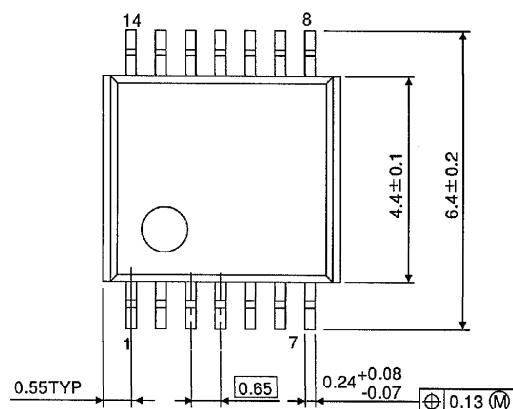
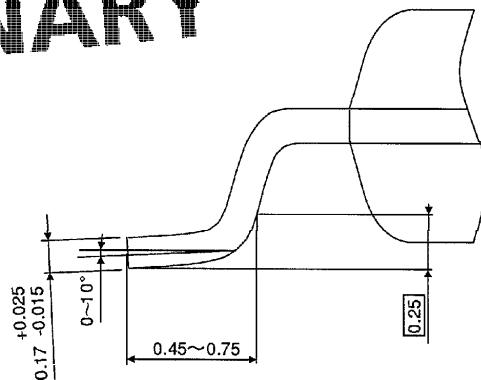
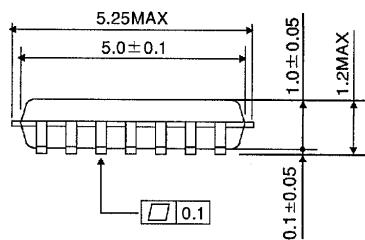
SYMBOL	V_{CC}		
	$3.3 \pm 0.3\text{V}$	$2.5 \pm 0.2\text{V}$	1.8V
V_{IH}	2.7V	V_{CC}	V_{CC}
V_M	1.5V	$V_{CC}/2$	$V_{CC}/2$

PRELIMINARY

OUTLINE DRAWING

TSSOP14-P-0044-0.65

Unit : mm

**PRELIMINARY**

Weight : 0.06g (Typ.)